

Vishay General Semiconductor

RoHS COMPLIANT

Ultrafast Avalanche SMD Rectifier



DO-214AC (SMA)

PRIMARY CHARACTERISTICS				
I _{F(AV)}	2.0 A			
V_{RRM}	50 V, 100 V, 200 V			
I _{FSM}	35 A			
I _R	1.0 μΑ			
V _F at I _F	1.1 V			
t _{rr}	25 ns			
E _R	20 mJ			
T _J max.	150 °C			
Package	DO-214AC (SMA)			
Diode variations	Single die			

FEATURES

- Low profile package
- · Ideal for automated placement
- · Glass passivated pallet chip junction
- Low reverse current
- Low forward voltage
- Soft recovery characteristic
- Ultra fast reverse recovery time
- Meets MSL level 1, per J-STD-020, LF maximum peak of 260 °C
- AEC-Q101 qualified
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912

TYPICAL APPLICATIONS

For use in high frequency rectification and freewheeling application in switching mode converters and inverters for consumer, computer, automotive, and telecommunication.

MECHANICAL DATA

Case: DO-214AC (SMA)

Molding compound meets UL 94 V-0 flammability rating Base P/N-E3 - RoHS-compliant, commercial grade Base P/NHE3 - RoHS-compliant, AEC-Q101 qualified

Terminals: Matte tin plated leads, solderable per

J-STD-002 and JESD 22-B102

E3 suffix meets JESD 201 class 2 whisker test, HE3 suffix

meets JESD 201 class 2 whisker test

Polarity: Color band denotes the cathode end

MAXIMUM RATINGS (T _A = 25 °C unless otherwise noted)						
PARAMETER	SYMBOL	BYG22A	BYG22B	BYG22D	UNIT	
Device marking code		BYG22A	BYG22B	BYG22D		
Maximum repetitive peak reverse voltage	V _{RRM}	50	100	200	V	
Average forward current	I _{F(AV)}	2.0			Α	
Peak forward surge current 10 ms single half sine-wave superimposed on rated load	I _{FSM}	35			А	
Pulse energy in avalanche mode, non repetitive (inductive load switch off) I _{(BR)R} = 1 A, T _J = 25 °C	E _R	20			mJ	
Operating junction and storage temperature range	T _J , T _{STG}	-55 to +150			°C	

BYG22A, BYG22B, BYG22D

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ELECTRICAL CHARACTERISTICS (T _A = 25 °C unless otherwise noted)							
PARAMETER	TEST CONDITIONS		SYMBOL	BYG22A	BYG22B	BYG22D	UNIT
Maximum instantaneous forward voltage	V (1)	1.0			V		
	I _F = 2.0 A	1j = 25 C	VF (1)	1.1			\ \ \ \ \ \
Maximum reverse current	V - V	T _J = 25 °C			1		
	$V_R = V_{RRM}$	$T_{\rm J} = 100 ^{\circ}{\rm C}$	IR	10			μΑ
Maximum reverse recovery time	I _F = 0.5 A, I _R = 1.0 A, I _{rr} = 0.25 A		t _{rr}	25		ns	

Note

 $^{^{(1)}}$ Pulse test: 300 μs pulse width, 1 % duty cycle

THERMAL CHARACTERISTICS (T _A = 25 °C unless otherwise noted)					
PARAMETER	SYMBOL	BYG22A BYG22B BYG22D		BYG22D	UNIT
Maximum thermal resistance, junction to lead, T _L = const.	$R_{\theta JL}$	25			°C/W
Maximum thermal resistance, junction to ambient	R _{θJA} ⁽¹⁾	150			
	R _{0JA} (2)	125		°C/W	
	R _{θJA} ⁽³⁾		100		

Notes

- (1) Mounted on epoxy-glass hard tissue
- (2) Mounted on epoxy-glass hard tissue, 50 mm² 35 μm Cu
- $^{(3)}$ Mounted on Al-oxide-ceramic (Al₂O₃), 50 mm² 35 μ m Cu

ORDERING INFORMATION (Example)					
PREFERRED P/N	UNIT WEIGHT (g)	PREFERRED PACKAGE CODE	BASE QUANTITY	DELIVERY MODE	
BYG22A-E3/TR	0.064	TR	1800	7" diameter plastic tape and reel	
BYG22A-E3/TR3	0.064	TR3	7500	13" diameter plastic tape and reel	
BYG22AHE3/TR (1)	0.064	TR	1800	7" diameter plastic tape and reel	
BYG22AHE3/TR3 (1)	0.064	TR3	7500	13" diameter plastic tape and reel	

Note

⁽¹⁾ AEC-Q101 qualified



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RATINGS AND CHARACTERISTICS CURVES (T_A = 25 °C unless otherwise noted)

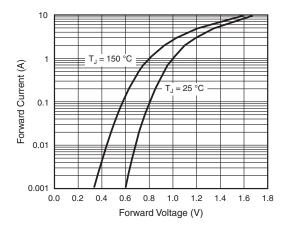


Fig. 1 - Forward Current vs. Forward Voltage

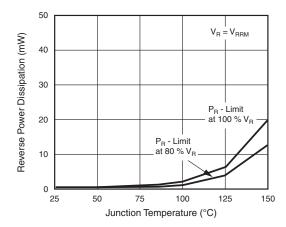


Fig. 4 - Max. Reverse Power Dissipation vs. Junction Temperature

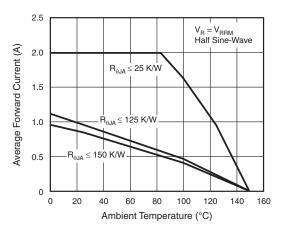


Fig. 2 - Max. Average Forward Current vs. Ambient Temperature

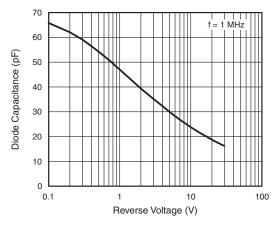


Fig. 5 - Diode Capacitance vs. Reverse Voltage

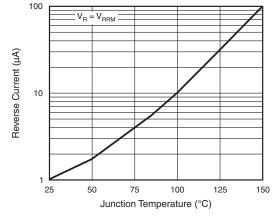


Fig. 3 - Reverse Current vs. Junction Temperature

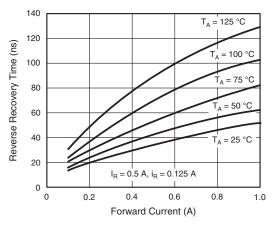
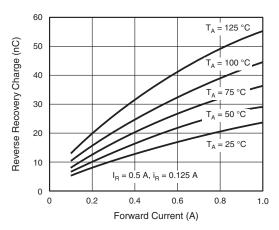
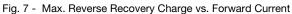


Fig. 6 - Max. Reverse Recovery Time vs. Forward Current



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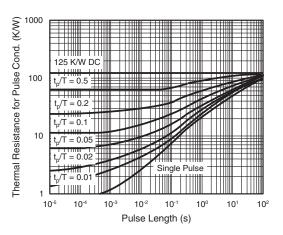
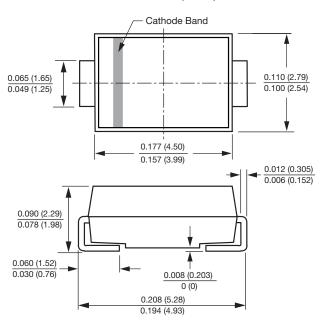


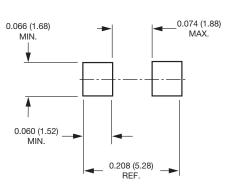
Fig. 8 - Thermal Response

PACKAGE OUTLINE DIMENSIONS in inches (millimeters)

DO-214AC (SMA)



Mounting Pad Layout





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